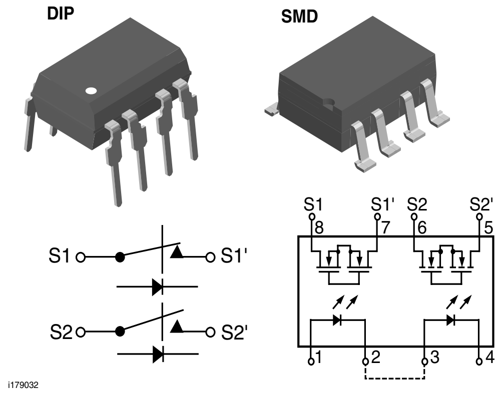
Dual 1 Form A/B, C Solid State Relay

Features

- Current Limit Protection
- Isolation Test Voltage 3750 V_{RMS}
- Typical R_{ON} 10 Ω
- Load Voltage 200 V
- Load Current 200 mA
- High Surge Capability
- Clean Bounce Free Switching
- Low Power Consumption
- SMD Lead Available on Tape and Reel
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Pb-free
e3



Agency Approvals

- UL1577, File No. E52744 System Code H or J, Double Protection
- CSA - Certification 093751

Applications

- General Telecom Switching
  - On/off Hook Control
  - Ring Delay
  - Dial Pulse
  - Ground Start
  - Ground Fault Protection
- Instrumentation
- Industrial Controls

Description

The LH1512 relays contain normally open and normally closed switches that can be used independently as a 1 Form A and 1 Form B relay, or when used together, as a 1 Form C relay. The relays are constructed as a mult.- chip hybrid device. Actuation control is via an Infrared LED. The output switch is a combination of a photodiode array with MOSFET switches and control circuity.

Order Information

Part	Remarks
LH1512BAC	Tubes, SMD-8
LH1512BACTR	Tape and Reel, SMD-8
LH1512BB	Tubes, DIP-8

Absolute Maximum Ratings, T_{amb} = 25 °C

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Ratings for extended periods of time can adversely affect reliability.

SSR

Parameter	Test condition	Symbol	Value	Unit
LED continuous forward current		I_F	50	mA
LED reverse voltage	$I_R \leq 10\ \mu A$	V_R	5.0	V
DC or peak AC load voltage	$I_L \leq 50\ \mu A$	V_L	200	V
Continuous DC load current (Form C operation)		I_L	200	mA
Peak load current, Form A	t = 100 ms	I_P	2)	

Parameter	Test condition	Symbol	Value	Unit
Peak load current (single shot) Form B		I_P	400	mA
Ambient operating temperature range		T_{amb}	- 40 to + 85	°C
Storage temperature range		T_{stg}	- 40 to + 125	°C
Pin soldering temperature	t = 10 s max	T_{sld}	260	°C
Input/output isolation test voltage	t = 1.0 s, I_{ISO} = 10 µA max	V_{ISO}	3750	V_{RMS}
Pole-to-pole isolation voltage (S1 to S2)[1] (dry air, dust free, at sea level)			1600	V
Output power dissipation (continuous)		P_{diss}	600	mW

[1] Breakdown occurs between the output pins external to the package.

[2] Refer to Current Limit Performance Application Note for a discussion on relay operation during transient currents.

Electrical Characteristics, T_{amb} = 25 °C

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

Input

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
LED forward current for switch turn-on (NO)	I_L = 100 mA, t = 10 ms	I_{Fon}		0.6	2.0	mA
LED forward current for switch turn-off (NO)	V_L = ± 150 V	I_{Foff}	0.2	0.5		mA
LED forward current for switch turn-on (NC)	I_L = 100 mA, t = 10 ms	I_{Fon}	0.2	0.9		mA
LED forward current for switch turn-off (NC)	V_L = ± 150 V	I_{Foff}		1.0	2.0	mA
LED forward voltage	I_F = 10 mA	V_F	1.15	1.26	1.45	V

Output

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
ON-resistance: (NO, NC)	I_F = 5.0 mA (NO), I_F = 0 mA (NC), I_L = 50 mA (NC)	R_{ON}		10	15	Ω
OFF-resistance: (NO)	I_F = 0 mA, V_L = ±100 V	R_{OFF}	0.35	5000		GΩ
OFF-resistance: (NC)	I_F = 5.0 mA, V_L = ±100 V	R_{OFF}	0.1	1.4		GΩ
Current limit: (NO)	I_F = 5.0 mA, t = 5.0 ms, V_L = ±5.0 V	I_{LMT}	270	360	460	mA
Off-state leakage current: (NO)	I_F = 0 mA, V_L = ±100 V	I_O		0.02	1000	nA
Off-state leakage current: (NC)	I_F = 5.0 mA, V_L = ±100 V	I_O		0.07	1.0	µA
Off-state leakage current: (NO, NC)	I_F = 0 mA (NO), I_F = 5.0 mA, V_L = ±200 V	I_O			1.0	µA
Output capacitance: (NO)	I_F = 0 mA, V_L = 50 V	C_O		60		pF
Output capacitance: (NC)	I_F = 5.0 mA, V_L = 50 V	C_O		60		pF

Transfer

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Capacitance (input-output)	V_{ISO} = 1.0 V	C_{IO}		3.0		pF
Turn-on time (NO)	I_F = 10 mA, I_L = 50 mA	t_{on}		1.4	3.0	ms
Turn-on time (NC)	I_F = 10 mA, I_L = 50 mA	t_{on}		1.2	3.0	ms
Turn-off time (NO)	I_F = 10 mA, I_L = 50 mA	t_{off}		0.7	3.0	ms
Turn-off time (NC)	I_F = 10 mA, I_L = 50 mA	t_{off}		2.0	3.0	ms

Typical Characteristics (Tamb = 25 °C unless otherwise specified)

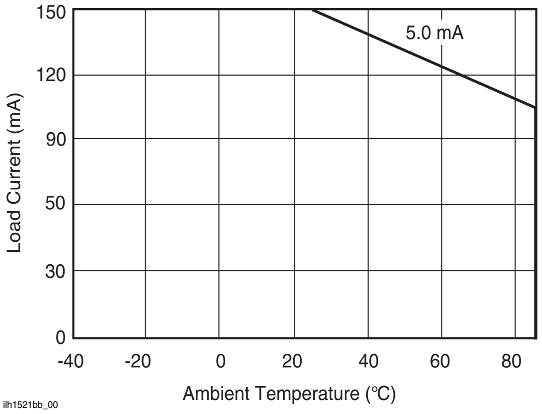


Figure 1. Recommended Operating Conditions

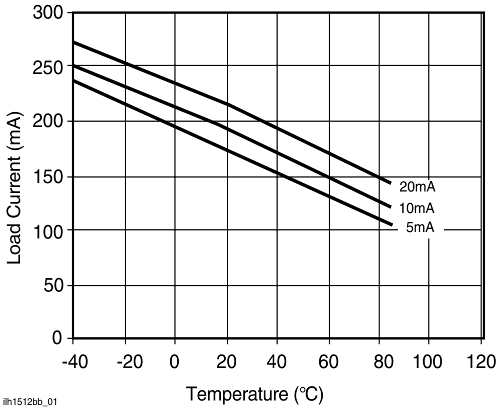


Figure 2. Form A_Typical Load Current vs. Temperature

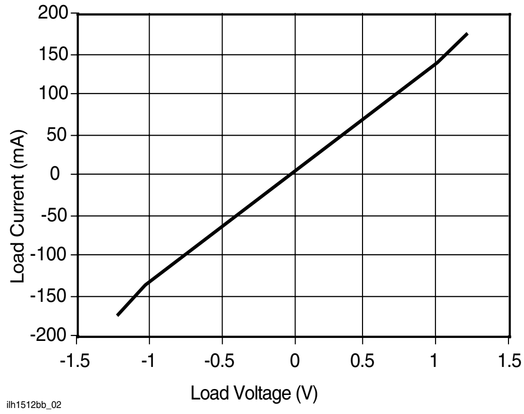


Figure 3. Form A_Typical Load Current vs. Load Voltage

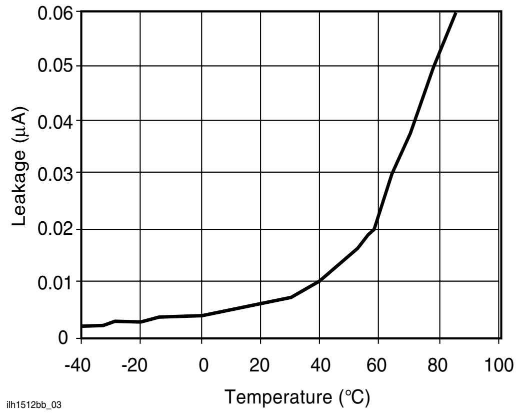


Figure 4. Typical Leakage vs. Temperature
(Measured across Pin 5&6 or 7&8)

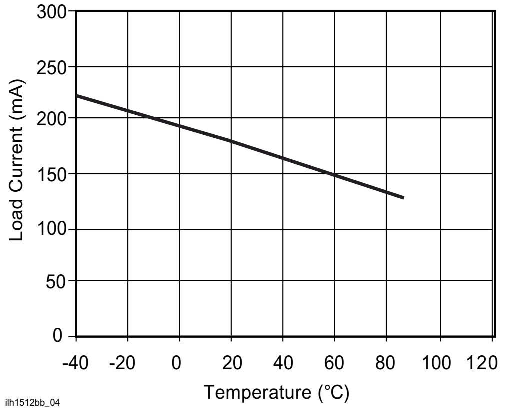


Figure 5. Form B_Typical Load Current vs. Temperature

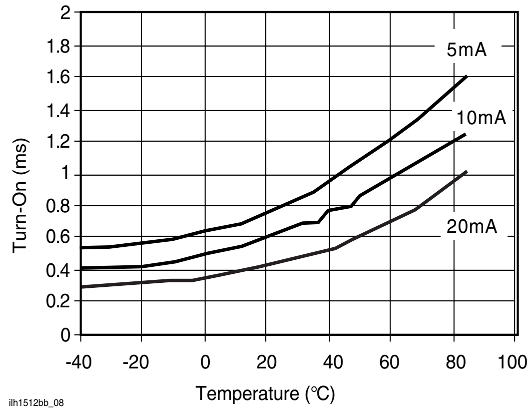


Figure 8. Form A_Typical Turn-On vs. Temperature

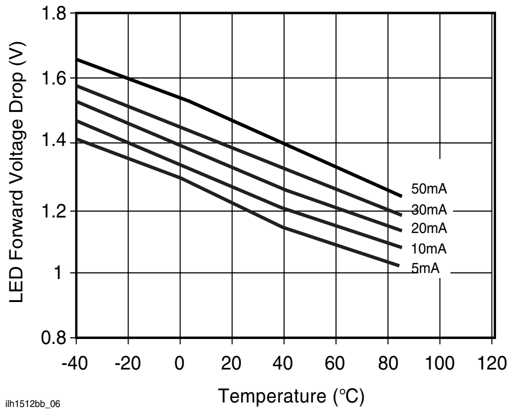


Figure 6. Typical LED Forward Voltage Drop vs. Temperature

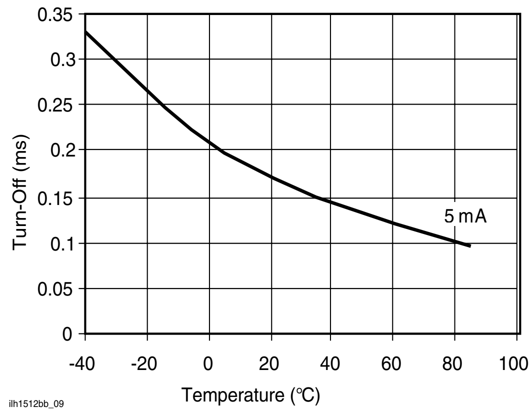


Figure 9. Form A_Typical Turn-Off vs. Temperature

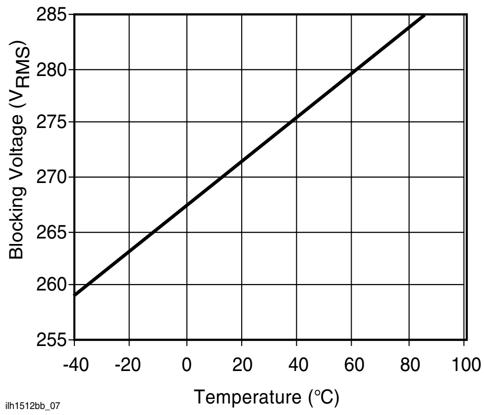


Figure 7. Form A_Typical Blocking Voltage vs. Temperature

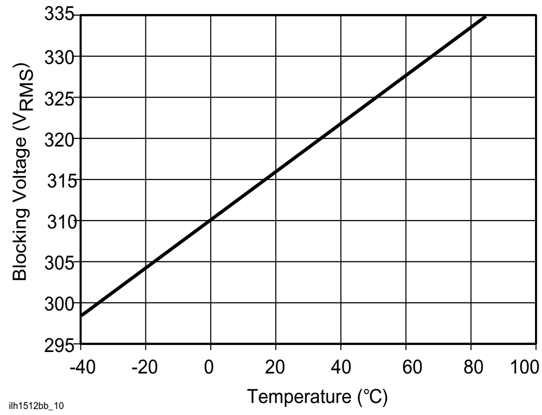


Figure 10. Form B_Typical Blocking Voltage vs. Temperature

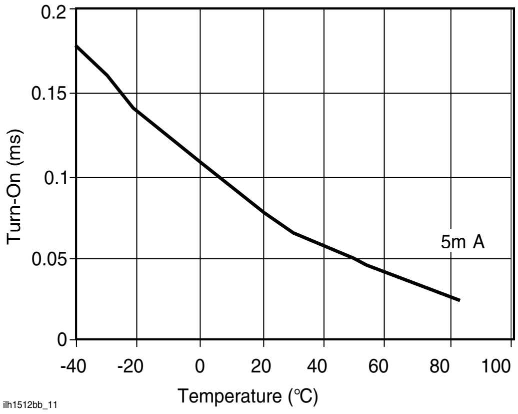


Figure 11. Form B_Typical Turn-On vs. Temperature

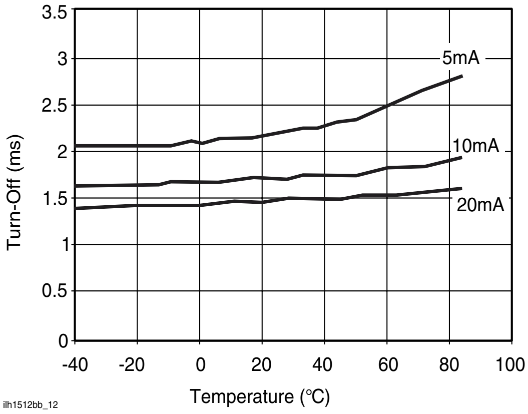


Figure 12. Form B_Typical Turn-Off vs. Temperature

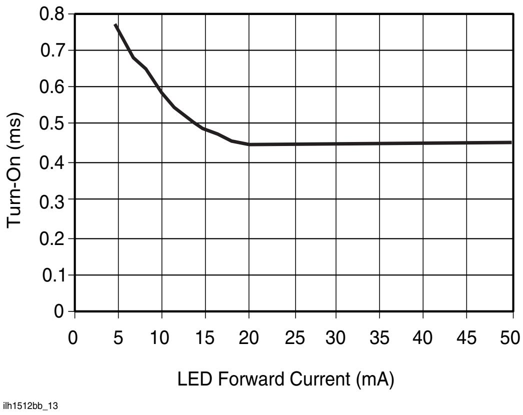


Figure 13. Form A_Typical Turn-On vs. LED Forward Current

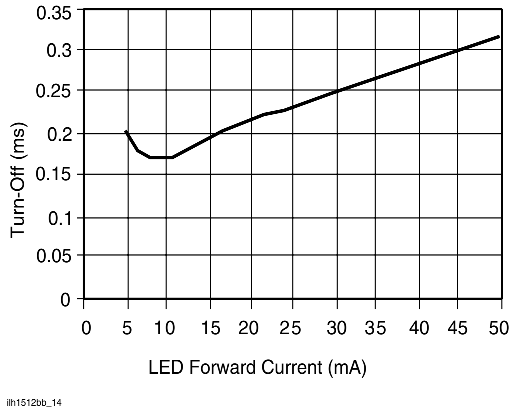


Figure 14. Form A_Typical Turn-Off vs. LED Forward Current

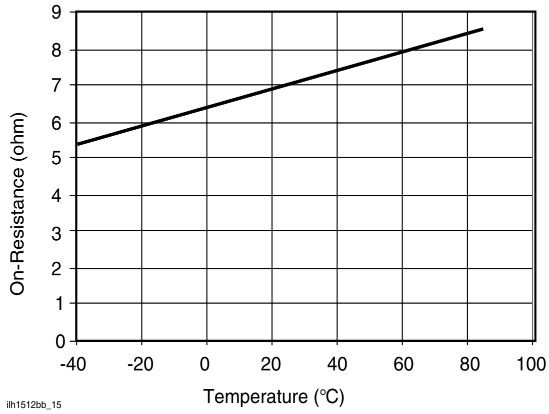


Figure 15. Form A_Typical On-Resistance vs. Temperature

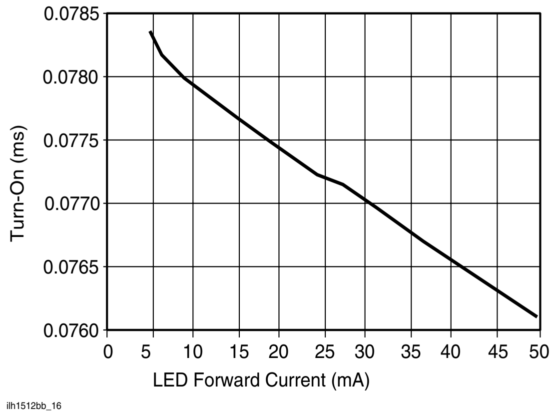


Figure 16. Form B_Typical Turn-On vs. LED Forward Current

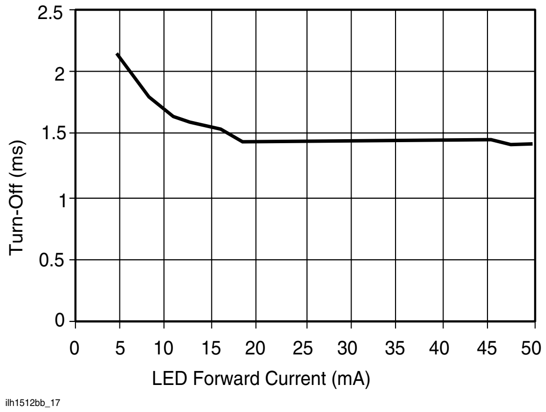


Figure 17. Form B_Typical Turn-Off vs. LED Forward Current

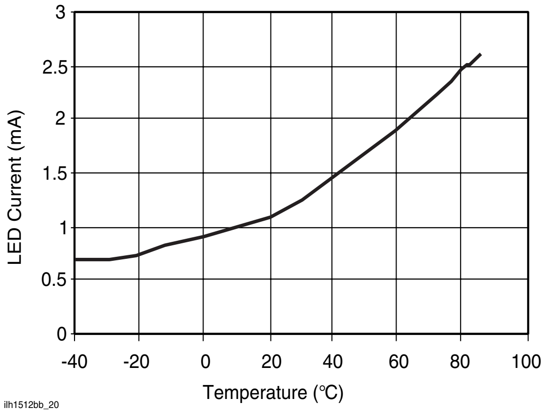


Figure 20. Form A_Typical I_F for Switch Dropout vs. Temperature

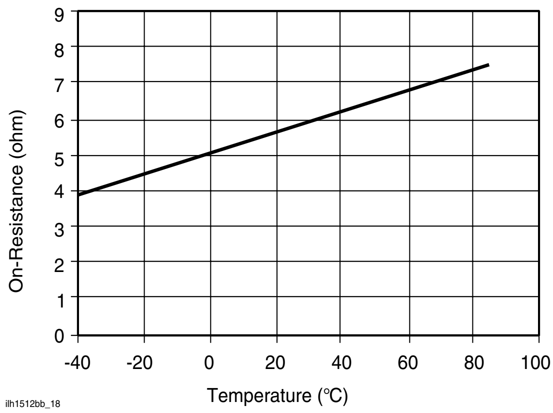


Figure 18. Form B_Typical On-Resistance vs. Temperature

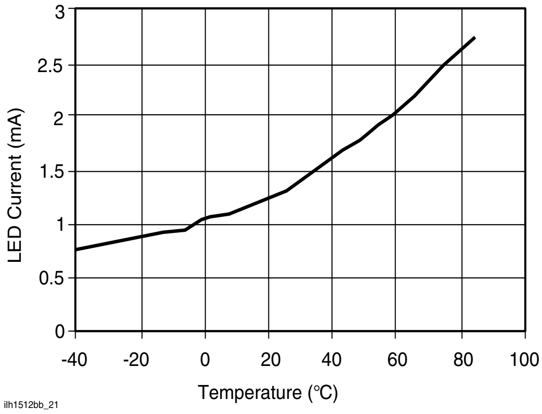


Figure 21. Form B_Typical I_F for Switch Operation vs. Temperature

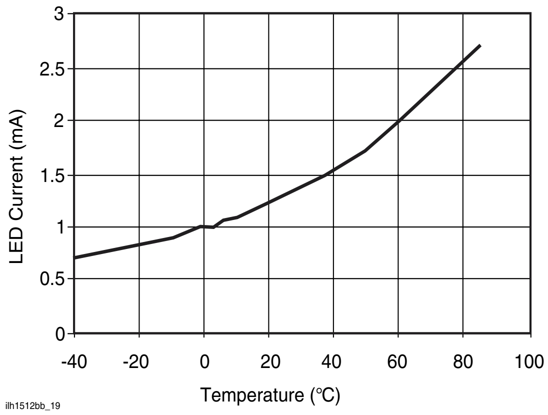


Figure 19. Form A_Typical I_F for Switch Operation vs. Temperature

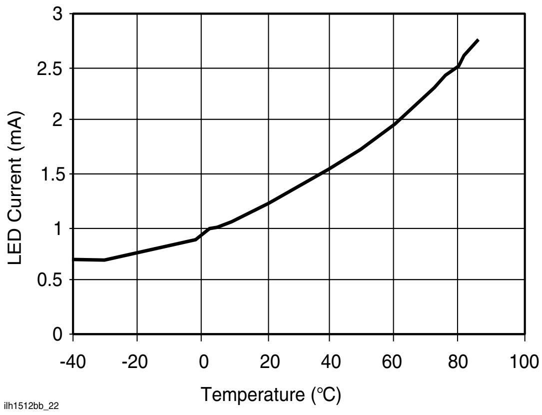
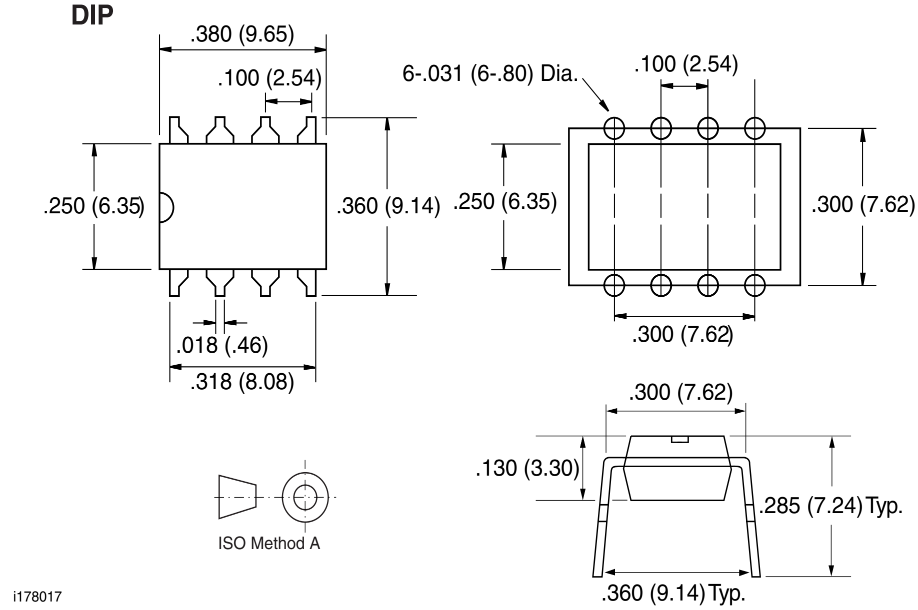
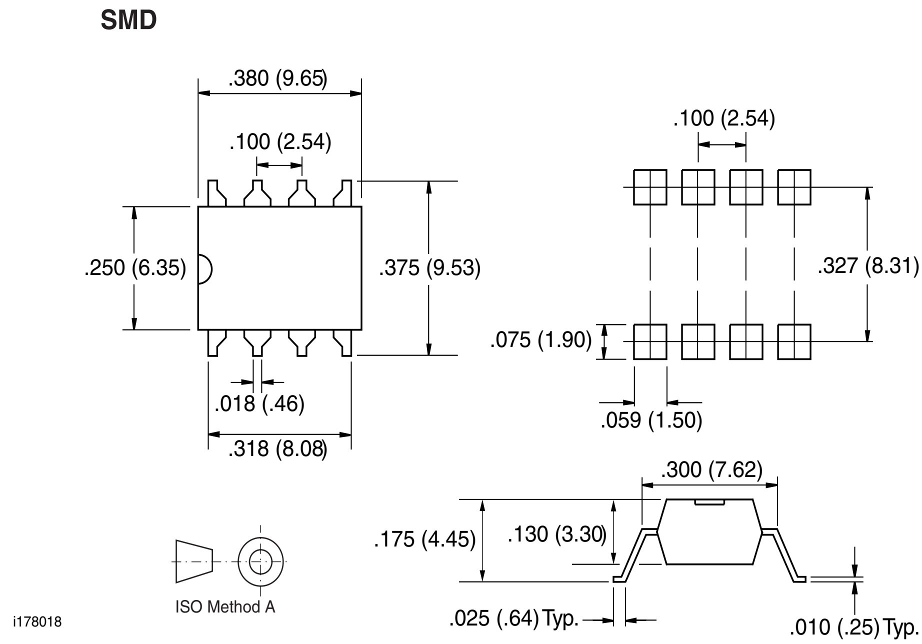


Figure 22. Form B_Typical I_F for Switch Dropout vs. Temperature

Package Dimensions in Inches (mm)



Package Dimensions in Inches (mm)



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

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